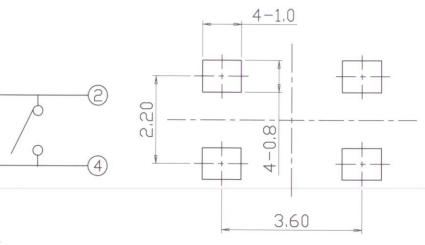


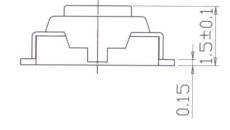


# P.C.B DIMENSION



## NOTE

- 1. OPERATING FORCE : 160±50gf
- 2. RATING : DC 12V 0.5mA
- 3. TRAVEL :  $0.20^{+0.2}_{-0.1}$  m/m
- 4. CONTACT RESISTANCE :  $100\text{m}\Omega$  MAX
- 5. GENERAL TOLERANCE : ±0.3
- 6. Knob size(L) : 1.5



PA	ART NO	PART NAM	IE Q	TY	MATERIAL	STANDARD	DISPOSITION	REMARKS	
<u>A</u>			TRIGON- OMETRY	UNIT	SCALE 1 1	SMD TACT SWITCH			
A			APPD	CHKD	DSGD	DUST PROOF TYPE			
$\Lambda$						MODEL INIT	F 4400F4F	۸	
NO	, CORRE	ECTION	06.12.20			INT-1188F15A			

# PART LIST

모델명(MODEL NO.): INT-1188F

DESIGN	CHECK	APPR

NO.	부품명 PART NAME	KOREA MATERIAL NAME	원재료업체 MATERIAL MANUFACTURER	원산지 ORIGIN		금 TING	색상 COLOR	비고 REMARKS
1	TERMINAL	C5210R-EH	POONGSAN METAL CO., LTD.	KOREA	AG	0.2 <i>μ</i> m		
2	CASE	LCP(VECTRA E130i)	POLYPLASTICS CO., LTD.	JAPAN			IVORY	
3	CONTACT	SUS 301-EH-AG	POSCO CO., LTD.	KOREA				2.5Ø, 120/160/250gf
4	DUST TAPE	POLYIMIDE TAPE	CHANG JO CORPORATION	KOREA			YELLOW	T:35±5μm
5	STEM/PUSH	LCP(VECTRA E130i)	POLYPLASTICS CO., LTD.	JAPAN			BLACK	
6	COVER	SUS 301 3/4-H	TAIHAN ELECTRIC WIRE CO., LTD.	KOREA				

INNOCENT ELECTRONICS CO.

#### 1. GENERAL MATTERS

- 1. 1 Application: This specification is applied to low current tactile switch for electronic equipment.
- 1. 2 Operating Temperature Range : -20  $^{\circ}$ C  $\sim$  70  $^{\circ}$ C, 45  $\sim$  85% RH
- 1. 3 Test Condition : The standard test conditions shall be 5  $^{\circ}$ C  $\sim$  35  $^{\circ}$ C in temperature,

 $45 \sim 85\%$  RH and  $860 \sim 1060$ mbar in atmospheric pressure. Should any doubt arise in judgment, tests shall be conducted at  $20 \pm 2 \, ^{\circ}\mathrm{C}$ ,  $65 \pm 5\%$  RH and  $860 \sim 1060$ mbar.

## 2. RATED VOLTAGE AND CURRENT

12V DC, 50mA

#### 3. ELECTRICAL PERFORMANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
3. 1	Contact Resistance	Measured at 50mA, 12V DC	100mΩ Max
3. 2	Insulation Resistance	DC 500C is applied between terminals and earth for 1 minute $\pm 5$ seconds.	100mΩ Min
3. 3	Withstand Voltage	250V AC( $50\sim60$ HZ ) is applied between terminals and earth for 1 minute.	No insulation defect shall be observed.
3. 4	Bounce	Measured by lightly striking the center of the button stem at a rate of 3 operation/sec.	10msec. Max

### 4. MECHANICAL PERFORMANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
4. 1	Operating Force	A gradually increasing load is applied to the center of the button stem.	160,200,250±50gf
4. 2	Terminal Strength	A static force of 320gf shall be applied to an arbitrary.	Shall be free from terminal looseness, damage and brea- kdown of insulator.
4.3	Stop Strength	A static force of 3Kgf shall be applied to the direction of operation for 3 seconds.	Shall be free from mechanical and electrical abnormalities.
4. 4	Solder Heat Resistance	Soldering temperature: 245 ~ 255°C Soldering time: 10sec.	Shall be free from mechanical and electrical degradation.
4.5	Travel		0.3 ± 0.1mm
4.6	Arrangement of action		Tactile feed-back

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5.	ENDURANCE
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	PROPERTY	TEST CONDITION	PERFORMANCE
5. 1	Operating Life	Measurements shall be made following the test set forth below:  1) 5V DC, 5mA resistive load.  2) Rate of operation 2 to 3 operations per second.  3) Depression: Twice the actuating force.  4) Cycles of operation: 50,000 cycles	Contact Resistance : $100 \text{m}\Omega$ Max Bounce : $20 \text{m}$ sec Max Actuating Force : within $\pm 50 \%$ of the initial value Item 3. 3
5. 2	Vibration Resistance	Measurements shall be made following the test set forth below:  *Range of oscillation: 10 to 55Hz  *Amplitude, pk-to-pk: 1.5mm  *Cycle of sweep: 10-55-10Hz in one minute, approx.  *Mode of sweep: logarithmical sweep or uniform sweep.  *Direction of oscillation:	Item 3. 1 Item 3. 2 Item 3. 3
5.3	Impact Shock Resistance	Measurements shall be made following the test set forth below:  *Acceleration: 80g  *cycle of test: 3 cycles each in 6 direction, for a total of 18 cycles.	Item 3. 1 Item 3. 2 Item 3. 3

#### 6. ENVIRONMENTAL

	PROPERTY	test conditions	PERFORMANCE
6. 1	Resistance to	Following the test set forth below the sample shall	Item 3. 1
	Low Temperature	be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements are made:	Item 3. 3
		*temperature : -30 ±2°C	
		*time : 96 hours	
		*waterdrops shall be removed.	
6.2	Heat Resistance	Following the test set forth below the sample shall	Item 3. 1
		be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements are made:  *temperature/time: 80 ±2°C/96hr	Item 3. 3

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#### 6. ENVIRONMENTAL

	PROPERTY	TEST CONDITION	PERFORMANCE
6.3	Moisture Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for one hour before measurements are made : $*temperature/time: 80 \pm 2^{\circ}\text{C}/96\text{hr}$	Contact Resistance: 100mΩ Max Insulation Resistance: 10MΩ Min Item 3. 3, 3. 4 Item 4. 1, 4. 5
6.4	Temperature Cycling	Following 5 cycles of the temperature cycling test set forth below the sample shall be left in normal temperature and humidity conditions for one hour during this test, waterdrops shall be removed.  1 cycle  1 cycle  2H  1H  2H  1H	Item 3. 1 Item 4. 1 Item 4. 5

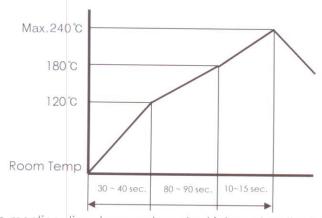
#### 7. REFLOW SOLDERING

7. 1 Refer to the following time temperature chart.

It is recommended to determine soldering conditions through verification test and on prior agreement of INNOCENT ELEC., since surface temperature varies depending upon material, size and thickness PCB.

#### 7.2 Other precautions

- 1) Switch shall not be washed after soldering with solvent or the like.
- 2) Soldering shall be controlled so as not to allow flux penetrates switch at its upper face.
- 3) Switch terminals and PCB upper face shall be free from flux prior to soldering.



Above-mentions time-temperature chart is based on the temperature in the part mounting surface of PCB.

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